

**PATENT ASSIGNMENT**

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
<b>CONVEYING PARTY DATA</b>											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Gong Tom Lei</td> <td>06/17/2010</td> </tr> <tr> <td>Yincai Liu</td> <td>06/17/2010</td> </tr> <tr> <td>Minsheng Li</td> <td>06/17/2010</td> </tr> <tr> <td>Jun Xiong</td> <td>06/17/2010</td> </tr> </tbody> </table>		Name	Execution Date	Gong Tom Lei	06/17/2010	Yincai Liu	06/17/2010	Minsheng Li	06/17/2010	Jun Xiong	06/17/2010
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Gong Tom Lei	06/17/2010										
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Minsheng Li	06/17/2010										
Jun Xiong	06/17/2010										
<b>RECEIVING PARTY DATA</b>											
Name:	FutureWei Technologies, Inc.										
Street Address:	1700 Alma Drive										
Internal Address:	Suite 500										
City:	Plano										
State/Country:	TEXAS										
Postal Code:	75075										
<b>PROPERTY NUMBERS Total: 1</b>											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12818845</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12818845						
Property Type	Number										
Application Number:	12818845										
<b>CORRESPONDENCE DATA</b>											
Fax Number:	(972)732-9218										
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NAME OF SUBMITTER:	Elya Westerheim										

CH \$40.00 12818845

Total Attachments: 1  
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**ASSIGNMENT**

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made; and


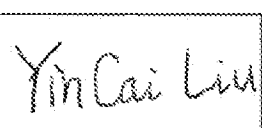
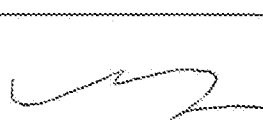
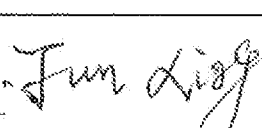
WHEREAS, FutureWei Technologies, Inc. ("FutureWei"), a corporation organized and existing under the laws of Texas, with its principal office at 1700 Alma Drive, Suite 500, Plano, TX 75075, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon in the United States and all other countries throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said FutureWei, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner for Patents to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said FutureWei, as assignee of my entire right, title and interest. I declare that I have not executed and will not execute any agreement in conflict herewith.

I also hereby sell and assign to FutureWei, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including, but not limited to, the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said FutureWei, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention or the file history thereof, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said FutureWei, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year;

TITLE OF INVENTION	<b>Signal Buffer Amplifier</b>			
SIGNATURE OF INVENTOR AND NAME	 <b>Gong Tom Lei</b>	 <b>Yincai Liu</b>	 <b>Minsheng Li</b>	 <b>Jun Xiong</b>
DATE	06/17/2010	06/17/2010	06/17/2010	06/17/2010
RESIDENCE (City, State)	Austin, TX	Santa Clara, CA	Santa Clara, CA	Santa Clara, CA